

## 4A Step-Down Regulator

### Description

The LX7180A is a 4A step-down regulator with integrated MOSFETs packaged in a space saving QFN12 2 mm x 2 mm for today's mobile devices. It uses an ultra-fast, constant frequency hysteretic control method to minimize external filter components while maintaining excellent regulation. The LX7180A reference voltage is programmable from 0.6 V to 1.195 V through a high speed (up to 3.4 MHz), bi-directional I2C bus.

The LX7180 operates from 3 V to 5.5 V rails and outputs 0.6 V to 100% of the input voltage.

Cycle-by-cycle current limiting protects against over-current conditions. Hiccup mode provides protection for heavy over-load or short-circuit faults. Thermal protection shuts down the regulator under over-temperature conditions. Over voltage conditions will immediately shut off the output to protect against permanent damage. The LX7180A automatically restarts when all fault conditions are cleared.

### Features

- 0-4 A Step-down Regulator
- Operational Input Supply Voltage Range: 3.0 V - 5.5 V (short durations to 6.5 V)
- Hysteretic Control Offers Best Transient Response
- PWM Switching at a Constant 1.65 MHz
- Power Save Mode (PSM) can be Selected to Improve Light Load Efficiency.
- 100% Duty Ratio Operation
- Input Under Voltage and Over Voltage Protection
- Enable and Power Good Function
- I2C Serial Interface at 3.4 Mbps
- Internal Soft-start
- Cycle-by-Cycle Over Current Protection
- Hiccup Mode Protects Against Short Circuit Faults
- Seven Bit Adjustable Reference Voltage via I2C Bus
- RoHS Compliant

### Applications

- High Performance HDD
- LCD TV
- Notebook/Netbook
- Server and Workstations
- Video Cards
- PoE Powered Devices Smart Phone

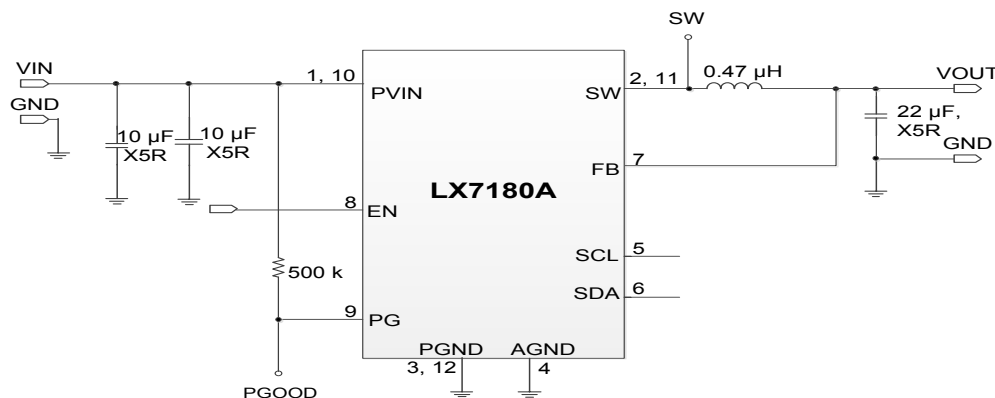


Figure 1 · Typical Application of LX7180A

## Pin Configuration and Pinout

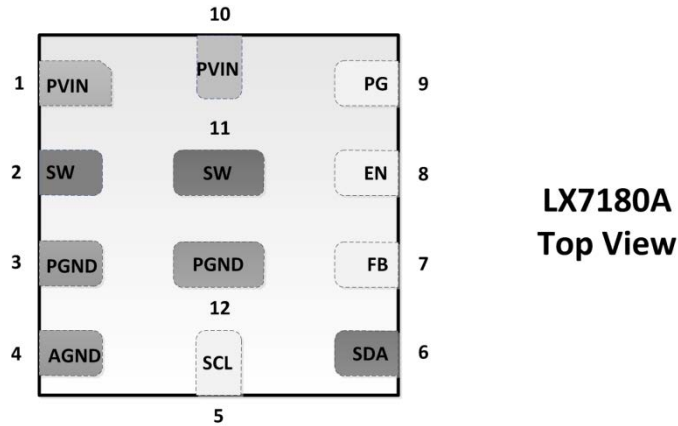


Figure 2 · Pinout Top View

Marking: “x” is the 2LSB bits of the binary I2C slave Address  
 “1” is for the set output voltage  
 YWWL = Year/Week/Lot Code  
 RoHS / Pb-free Matte Tin Pin Finish

## Ordering Information

Ambient Temperature	Type	Package	Slave Address	Set Output Voltage	Part Number	Packaging Type
0°C to 85°C	RoHS Compliant, Pb-free	QFN 2X2 mm 12L	0	0.9 V	LX7180A - 01CLQ	Bulk
			1		LX7180A - 11CLQ	
			2		LX7180A - 21CLQ	
			3		LX7180A - 31CLQ	
					LX7180A - xyCLQ*	
			0	0.9 V	LX7180A - 01CLQ-TR	Tape and Reel
			1		LX7180A - 11CLQ-TR	
			2		LX7180A - 21CLQ-TR	
3	LX7180A - 31CLQ-TR					
		LX7180A - xyCLQ-TR*				

- Note: 1. \* Consult factory for other I2C slave address and set output voltage options.  
 2. “x” is the 2 LSB bits of the binary I2C slave address (0 to 3).  
 3. “y” is the set output voltage (0 is 0.6 V, 1 is 0.9 V, 2 is 0.95 V, 3 is 0.97 V).

## Pin Description

Pin Number	Pin Designator	Description
1, 10	PVIN	Supply Voltage. Bypass PVIN to ground plane as close as possible to the IC.
2, 11	SW	Switch Output. Drives the external L-C filter.
3, 12	PGND	Power Ground. Connect to ground plane.
4	AGND	Analog Ground. Connect to ground plane.
5	SCL	I2C Serial Clock Digital Input.
6	SDA	I2C Serial Data. Digital Input/Output.
7	FB	Feedback – Analog input, monitors the output voltage either directly or through a resistor divider.
8	EN	Enable – Digital input. Force high to enable the IC.
9	PG	Power Good – Open drain digital output. Pulls low to indicate a fault condition. Requires an external pull up resistor.

## Block Diagram

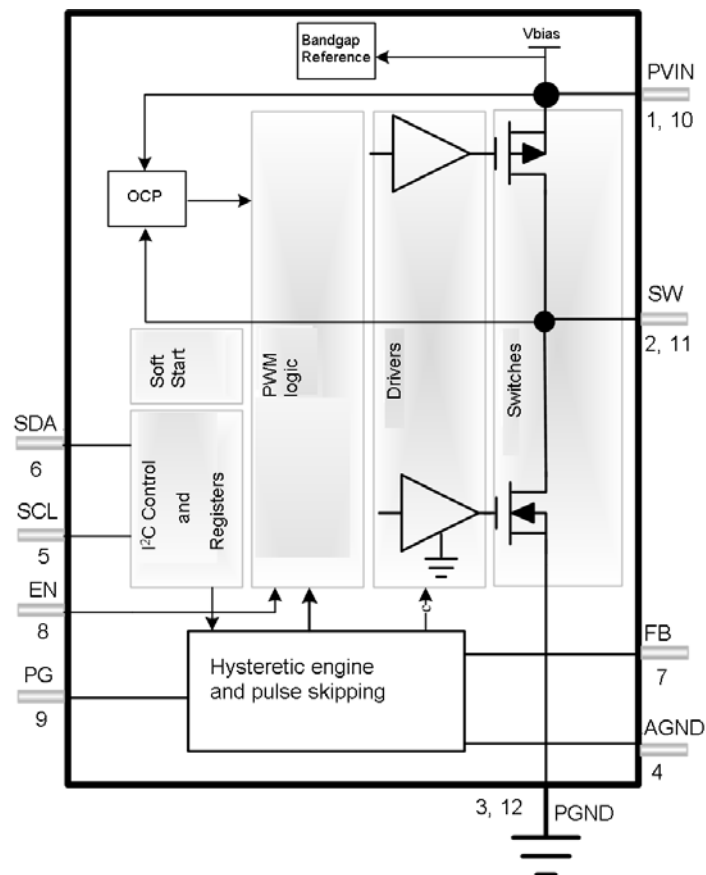


Figure 3 · Block Diagram of LX7180A

## Absolute Maximum Ratings

Parameter	Min	Max	Units
PVIN, EN, PG, SCL, SDA, SW to GND	-0.3	7	V
AGND to GND	-0.3	0.3	V
SW to GND (Shorter than 50 ns)	-2	7	V
Junction Temperature Range	-10	150	°C
Storage Temperature Range	-65	150	°C
Peak Lead Soldering Temperature (40s, reflow)		260 (+0, -5)	°C

**Note:** Performance is not necessarily guaranteed over this entire range. These are maximum stress ratings only. Exceeding these ratings, even momentarily, can cause immediate damage, or negatively impact long-term operating reliability.

## Operating Ratings

Performance is generally guaranteed over this range as further detailed are provided in [Electrical Characteristics](#) section.

Parameter	Min	Max	Units
Input Voltage	3.0	5.5	V
Output Voltage	0.6	5.5	V
Output Current (VIN = 3 V to 5 V)	0	4	A
Ambient Temperature	0	85	°C

**Note:** Corresponding Max Junction Temperature is 125°C.

## Thermal Properties

Thermal Resistance( $\theta_{JA}$ )	Typ	Units
QFN 2x2mm 12L	30	°C/W

**Note:** The  $\theta_{JA}$  number assumes no forced airflow. Junction Temperature is calculated using  $T_J = T_A + (P_D \times \theta_{JA})$ . In particular,  $\theta_{JA}$  is a function of the PCB construction. The stated number above is for a four-layer board in accordance with JESD-51 (JEDEC).

## Electrical Characteristics

Unless otherwise specified, the following specifications apply over the operating ambient temperature of  $0^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$  with the following test conditions:  $PV_{IN} = 5\text{ V}$ . Typical parameters refers to  $T_J = 25^{\circ}\text{C}$ .  $V_{OUT}$  is connected directly to FB for closed loop tests (default test condition).  $V_{REF}$  is set to 0.9 V.  $V_{OUT}$  is disconnected from FB for open loop tests. Default registers settings.  $I_{load} = 0$ . EN=high. GBD specifications are guaranteed by design and/or characterization and are not tested on a production basis. SCL and SDA set to  $PV_{IN}$ .

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>VIN</b>						
$I_{QPSM}$	PSM Bias Current	Enable PSM. Force FB to 1 V open loop.		350		$\mu\text{A}$
$I_{SLEEP}$	Input Current at Shutdown	EN = low		0.1	3	$\mu\text{A}$
$I_{In\_I2C}$	I2C Shutdown Sleep Current	Set VSEL(7)=low, EN=high.		20		$\mu\text{A}$
$UVLO_{RISING}$	Under Voltage Rising Threshold	$PV_{IN}$ rising			2.8	V
$UVLO_{HYST}$	UVLO Hysteresis	$PV_{IN}$ falling		0.2		V
$OVP_R$	Over Voltage Rising Threshold	$PV_{IN}$ rising. Will also trigger on $DV/DT > 1\text{ V}/\mu\text{s}$		6.1		V
$OVP_F$	Over Voltage Falling Threshold	$PV_{IN}$ falling	5.5	5.85		V
<b>VREF</b>						
$V_{REFMIN}$	Minimum Reference Voltage	VSEL(6:0) = 00h.		0.6		V
$V_{REFMEAN}$	Mean Reference Voltage	VSEL(6:0) = 40h.		0.9		V
$V_{REFMAX}$	Maximum Reference Voltage	VSEL(6:0) = 7Fh.		1.195		V
$T_{SS}$	$V_{REF}$ Slew Rate			5		$\text{mV}/\mu\text{s}$
$T_{HICCUP}$	Hiccup Time			1.2		ms
<b>FB</b>						
$V_{FBSET}$	$V_{FB}$ Set Point Accuracy	Enable PWM. VSEL(6:0) = 40h	0.891	0.9	0.909	V
		Enable PWM. VSEL(6:0) = 00h	0.591	0.6	0.609	V
		Enable PWM. VSEL(6:0) = 7Fh	1.177	1.195	1.213	V
$V_{FBPWM}$	PWM FB Accuracy	Enable PWM. $T_A = 25^{\circ}\text{C}$ $PV_{IN} = 3\text{ V}$ , $I_{OUT} = 0\text{ A}$ $PV_{IN} = 3\text{ V}$ , $I_{OUT} = 1\text{ A}$ $PV_{IN} = 5.5\text{ V}$ , $I_{OUT} = 0\text{ A}$ $PV_{IN} = 5.5\text{ V}$ , $I_{OUT} = 1\text{ A}$ , Note 1	0.886	0.9	0.914	V

Symbol	Parameter	Conditions	Min	Typ	Max	Units
VFB <sub>PSM</sub>	PSM FB Accuracy	Enable PSM. T <sub>A</sub> = 25°C PVIN = 3 V, I <sub>OUT</sub> = 0 A PVIN = 3 V, I <sub>OUT</sub> = 1 A PVIN = 5.5 V, I <sub>OUT</sub> = 0 A PVIN = 5.5 V, I <sub>OUT</sub> = 1 A, Note 1	0.882	0.9	0.918	V
VFB <sub>LRPWM</sub>	PWM Load Regulation	I <sub>LOAD</sub> = 0 A to 4 A. Note 1		-0.17		%/A
	PWM Line Regulation	V <sub>OUT</sub> = 0.9 V. PVIN from 3 V to 5.5 V, Enable PWM, I <sub>LOAD</sub> = 0.1 A. Note 1		0.06		%/V
	PSM Line Regulation	V <sub>OUT</sub> = 0.9 V. PVIN from 3 V to 5.5 V, Enable PSM, I <sub>LOAD</sub> = 0.1 A. Note 1		0.07		%/V
FB <sub>IL</sub>	FB Input Current				1	μA
FB <sub>UV</sub>	FB Under Voltage Threshold	V <sub>OUT</sub> below this threshold will initiate a hiccup sequence.		80		%V <sub>REF</sub>
R <sub>DISC</sub>	Output Discharge Resistance	EN = low	80	314	500	Ω
<b>SW</b>						
R <sub>DSON_H</sub>	High Side On Resistance			46		mΩ
R <sub>DSON_L</sub>	Low Side On Resistance			21		mΩ
I <sub>RATED</sub>	Rated Output Current	PVIN = 3 V to 5 V. Note 1	4			A
I <sub>CL</sub>	Current Limit	Peak inductor current. PVIN = 3 V to 5 V. Note 1	5.7	7	8.6	A
T <sub>SH</sub>	Thermal Shutdown Threshold	Note 1		150		°C
T <sub>H</sub>	Thermal Shutdown Hysteresis	Note 1		20		°C
F <sub>SW</sub>	PWM Switching Frequency	V <sub>OUT</sub> ≥ 1.8 V, T=25°C	1.55	1.65	1.75	MHz
<b>EN, SDA (as input), SCL</b>						
V <sub>IH</sub>	Input High				1.1	V
V <sub>IL</sub>	Input Low		0.4			V
I <sub>IN</sub>	Input Current			0.01	1	μA
<b>PG</b>						
V <sub>PG90</sub>	PGOOD V <sub>OUT</sub> Lower Threshold	V <sub>OUT</sub> rising		90		% V <sub>REF</sub>
V <sub>PG110</sub>	PGOOD V <sub>OUT</sub> Upper Threshold	V <sub>OUT</sub> falling		110		% V <sub>REF</sub>

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V <sub>PGHY</sub>	Hysteresis			5		% V <sub>REF</sub>
P <sub>G<sub>RDSON</sub></sub>	PGOOD Pull-down Resistance			13	50	Ω
P <sub>G<sub>I</sub>LEAK</sub>	PGOOD Leakage Current	T <sub>J</sub> = 25°C		0	1	μA
P <sub>G<sub>D</sub>DELAY</sub>	PGOOD Delay		25	45	65	ms

Note: These parameters are not tested, but guaranteed by design and characterization.

## Typical Performance Curves -- (Efficiency)

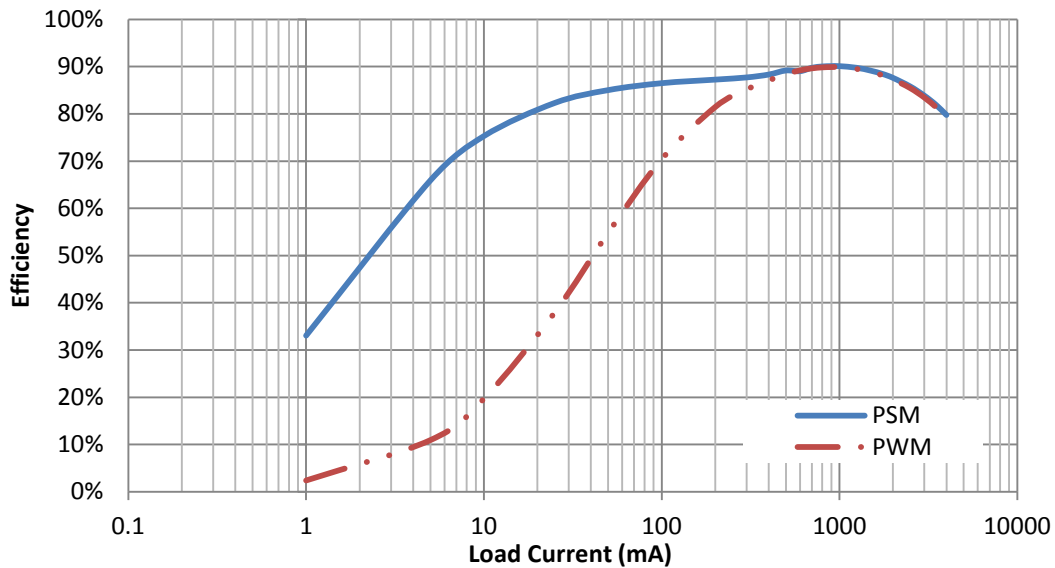
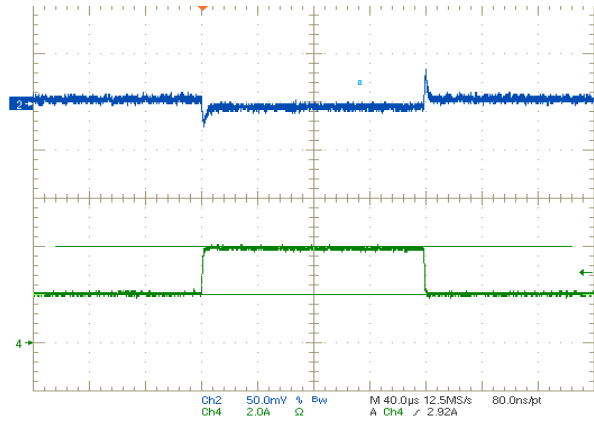
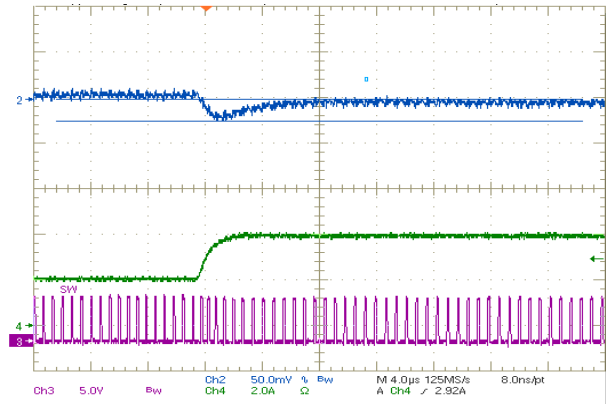


Figure 4 · LX7180A Efficiency with V<sub>IN</sub> = 5 V, V<sub>OUT</sub> = 0.9 V, L = 1.0 μH, C<sub>OUT</sub> = 66 μF

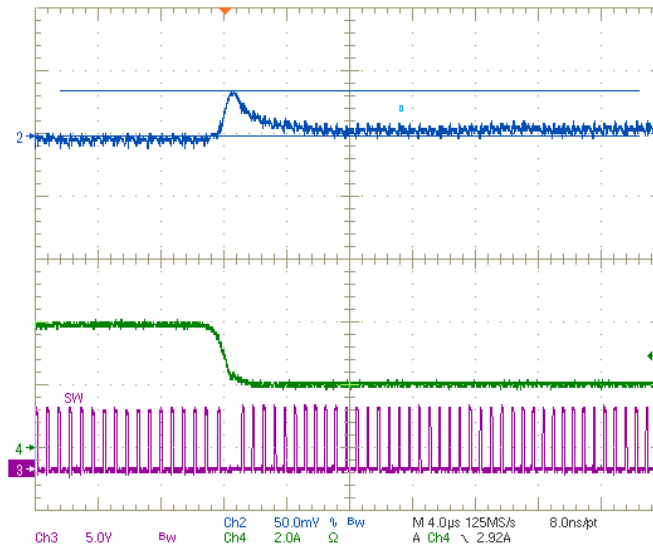
## Step Response (Load Current = 2A to 4A, $L = 0.47 \mu\text{H}$ , $C_{\text{OUT}} = 22 \mu\text{F}$ )



**Figure 5 · Step Response**



**Figure 6 · Step Response Rising Edge**



**Figure 7 · Step Response Falling Edge**



# I2C Timing Specifications

**Table 1 · I2C Timing Specifications**

Symbol	Parameter	Conditions	C <sub>b</sub> = 100 pF (max) (Note 2)		C <sub>b</sub> = 400 pF		Unit
			Min	Max	Min	Max	
f <sub>SCHL</sub>	SCLH and SCL clock frequency		0	3.4	0	0.4	MHz
t <sub>SU;STA</sub>	Set-up time for a repeated START condition		160	-	600	-	ns
t <sub>HD;STA</sub>	Hold time (repeated) START condition		160	-	600	-	ns
t <sub>LOW</sub>	LOW period of the SCL clock		160	-	1300	-	ns
t <sub>HIGH</sub>	HIGH period of the SCL clock		60	-	600	-	ns
t <sub>SU;DAT</sub>	Data set-up time		10	-	100	-	ns
t <sub>HD;DAT</sub>	Data hold time		47	70	0	-	ns
t <sub>rCL</sub>	Rise time of SCLH signal		10	40	20*0.1C <sub>b</sub>	300	ns
t <sub>rCL1</sub>	Rise time of SCLH signal after a repeated START condition and after an acknowledge bit		10	80	20*0.1C <sub>b</sub>	300	ns
t <sub>rCL</sub>	Fall time of SCLH signal		10	40	20*0.1C <sub>b</sub>	300	ns
t <sub>rDA</sub>	Rise time of SDAH signal		10	80	20*0.1C <sub>b</sub>	300	ns
t <sub>fDA</sub>	Fall time of SDAH signal		10	80	20*0.01C <sub>b</sub>	300	ns
t <sub>SU;STO</sub>	Set-up time for STOP condition		160	-	600	-	ns
t <sub>BUF</sub>	Bus free time between a STOP and START condition		160	-	1300	-	ns
t <sub>VD;DAT</sub>	Data valid time		-	160	-	900	ns
t <sub>VD;ACK</sub>	Data valid acknowledge time		-	160	-	900	ns
C <sub>b</sub>	Capacitive load for each bus line	SDAH and SCLH lines	-	100		400	pF
		SDAH + SDA line and SCLH + SCL line	-	400		400	pF

- Note:** 1. All values referred to V<sub>IH</sub> (min) and V<sub>IL</sub> (max) levels of I/O stages table.  
 2. Loads in excess of 100 pF will restrict bus operation speed below 3.4 MHz.

## Theory of Operation / Application Information

### Basic Operation

The LX7180A compares the FB voltage to an internal reference,  $V_{REF}$ . When FB is lower than  $V_{REF}$ , the upper switch turns on and the lower switch turns off. When FB is higher than  $V_{REF}$ , the upper switch turns off and the lower switch turns on. An internal ramp and a frequency control loop keep the switching frequency constant when in constant conduction mode (CCM) over a wide range of output capacitor values and parasitic components (i.e. ESR, ESL).

At light loads, if enabled, the converter automatically reduces the switching frequency to optimize efficiency.

An integrated I2C bus interface, operating up to 3.4 Mbps, allows the following user programmability to the converter:

- On the fly programming of the reference voltage in 4.7 mV increments.
- Enable / Disable the regulator.
- Enable power save mode (PSM) or limit operation to continuous conduction only (PWM).
- Set the  $V_{REF}$  slew rate.
- Enable/Disable VIN over voltage protection.
- Force PGOOD to respond to both under and over voltages or just under voltage.

### Setting the Output Voltage

The reference voltage can be programmed with the I2C bus  $V_{SEL}$  register value.

$$V_{REF} = 0.6 \text{ V} + V_{SEL} \cdot 0.0047 \text{ V} \dots\dots\dots (2)$$

Where  $V_{SEL}$  is programmable from 0 to 127.

### Startup

The LX7180A is enabled when EN is high and PVIN rises above the UVLO threshold. At start up, after all the internal bias voltages and currents stabilize,  $V_{REF}$  ramps up from 0 V to the target voltage at the defined slew rate. While  $V_{REF}$  ramps, PGOOD is held low. At the end of the ramp time, PGOOD is allowed to go high 45 ms after FB has reached the PGOOD rising threshold. During the ramp time, the LX7180A always runs in PSM to allow discontinuous operation. This switchover is independent of the programmed MODE bit setting.

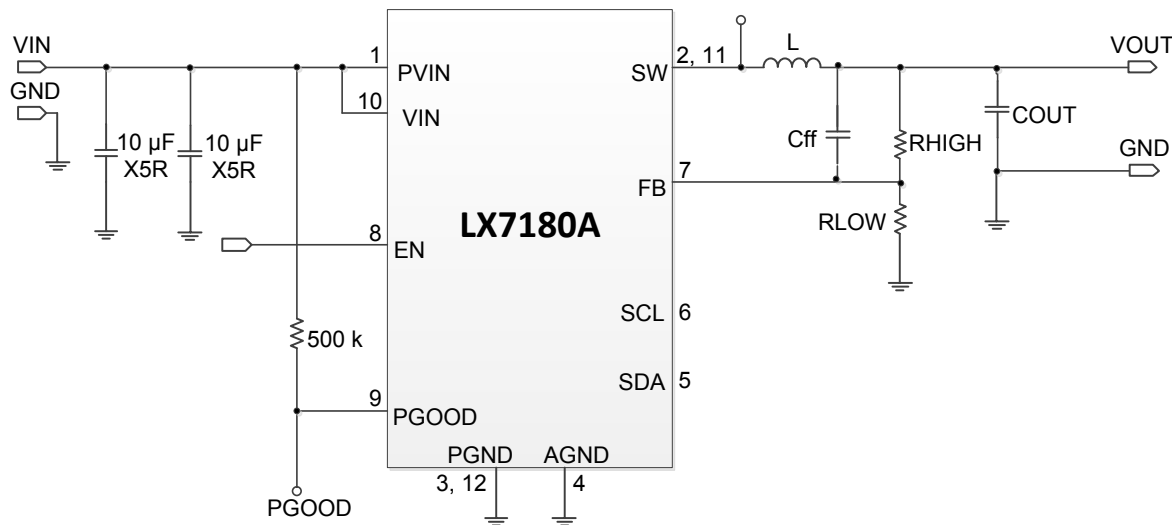
### Over Current Protection

The LX7180A protects against all types of short circuit conditions. Cycle-by-cycle over current protection turns off the upper switch when the current exceeds the ICL threshold. When this occurs, the upper switch is kept off for about 360 ns before being allowed to turn on again. After startup, if FB drops below the  $FB_{UV}$  threshold, a hiccup sequence will be initiated where both output switches are shut off for 1.2 ms before initiating another soft start. This protects against a crowbar short circuit. FB under voltage detection is not active during startup.

## Recommended Output Filter Components

The following tables show the recommended feedback component values ( $R_{HIGH}$ ,  $R_{LOW}$ ,  $C_{ff}$ ) for different input/output voltages, power inductor ( $L$ ), and output capacitance ( $C$ ) values that result in optimum closed loop response of the regulator in each case. The estimated crossover frequency is also shown in the table in each case. If the  $L \cdot C$  factor exceeds a certain number the regulator would run with low phase margin or become unstable. The  $L$  and  $C$  range provided in the table provides  $30^\circ$ , or higher of phase margin. Therefore, it is not recommended to increase  $L \cdot C$  factor beyond what is given in the table.

It is a good practice to determine  $L$  such that the peak-to-peak inductor ripple current in continuous conduction mode operation is roughly equal to 30% of converter's rated output current. In general, increasing the inductance slows down the closed loop response of the regulator. Hence, for applications that require fast line/load transient response, lower inductance values should be preferred over larger ones. Output capacitance can be determined based on desired output ripple voltage staying within the limits provided in the table depending on the inductance value.



## Recommended Output Filter Components - Continued

$V_{IN}$ (V)	$V_{OUT}$ (V)	L ( $\mu$ H)	$C_{OUT}$ ( $\mu$ F)	$R_{HIGH}$ (k $\Omega$ )	$R_{LOW}$ (k $\Omega$ )	Cff (pF)	F crossover (kHz)
5.0	0.9	2.2	2x22	0	$\infty$	none	110
			1x22				180
		1.5	4x22				95
			3x22				110
			2x22				140
			1x22				240
			1.0				5x22
		4x22					120
		3x22					140
		2x22					190
		1x22					325
		0.47	5x22				170
			4x22				200
			3x22				240
			2x22				350
			1x22				650
		0.33	5x22				220
			4x22				260
			3x22				325
			2x22				475

Note:  $V_{REF} = 0.6$  V, if FB network exists.

## Recommended Output Filter Components - Continued

$V_{IN}$ (V)	$V_{OUT}$ (V)	L ( $\mu$ H)	$C_{OUT}$ ( $\mu$ F)	$R_{HIGH}$ ( $k\Omega$ )	$R_{LOW}$ ( $k\Omega$ )	Cff (pF)	F crossover (kHz)
3.0	0.9	2.2	1x22	0	$\infty$	none	130
			2x22				110
		1.5	1x22				162
			1.0				3x22
		2x22					140
		1x22					220
		0.47	5x22				120
			4x22				140
			3x22				170
			2x22				220
			1x22				400
			0.33				5x22
		4x22					180
		3x22					220
		2x22					300
		1x22					550

## Recommended Output Filter Components – Continued

$V_{IN}$ (V)	$V_{OUT}$ (V)	L ( $\mu$ H)	$C_{OUT}$ ( $\mu$ F)	$R_{HIGH}$ (k $\Omega$ )	$R_{LOW}$ k( $\Omega$ )	Cff (pF)	F crossover (kHz)
5.0	1.8	2.2	5x22	240	120	20	49
			4x22				57
			2x22				70
			3x22			15	85
							1x22
		1.5	5x22			15	58
			4x22				68
			3x22				84
			2x22				120
			1x22				200
		1.0	5x22	15	77		
			4x22		92		
			3x22		120		
			2x22		8	130	
			1x22			260	
		0.47	5x22	8	110		
			4x22		130		
			3x22		180		
			2x22		120	60	190
			1x22		475		
		0.33	5x22	240	120	8	150
			4x22				190
			3x22				260
			2x22	60	30	220	
1x22	500						

## Recommended Output Filter Components – Continued

$V_{IN}$ (V)	$V_{OUT}$ (V)	L ( $\mu$ H)	$C_{OUT}$ ( $\mu$ F)	$R_{HIGH}$ (k $\Omega$ )	$R_{LOW}$ (k $\Omega$ )	Cff (pF)	F crossover (kHz)
3.0	1.8	2.2	5x22	240	120	20	36
			4x22				42
			3x22				50
			2x22			60	
			1x22			100	
		1.5	15			5x22	42
						4x22	49
						3x22	60
						2x22	79
						1x22	140
		1.0	15			5x22	55
						4x22	64
						3x22	79
						2x22	87
						1x22	150
		0.47	8			5x22	76
						4x22	89
						3x22	110
						2x22	160
						1x22	350
		0.33	8			5x22	97
						4x22	120
						3x22	150
						2x22	240
1x22	525						

## Recommended Output Filter Components – Continued

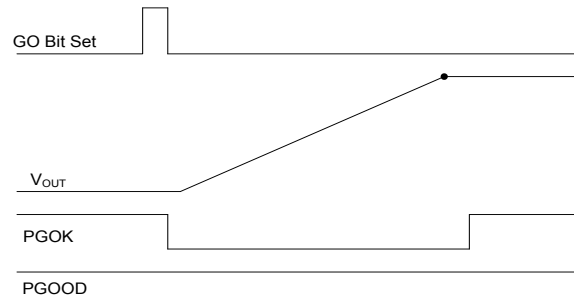
$V_{IN}$ (V)	$V_{OUT}$ (V)	L ( $\mu$ H)	$C_{OUT}$ ( $\mu$ F)	$R_{HIGH}$ (k $\Omega$ )	$R_{LOW}$ (k $\Omega$ )	Cff (pF)	F crossover (kHz)		
5.0	3.3	2.2	5x22	540	120	30	58		
			4x22				67		
			2x22				81		
			3x22				110		
			1x22				170		
		1.5	5x22				75		
			4x22				87		
			3x22				100		
			2x22				140		
			1x22				240		
		1.0	5x22			43	100		
			4x22				120		
			3x22				140		
			2x22				190		
			1x22				325		
		0.47	5x22			43	170		
			4x22				200		
			3x22				240		
			2x22				350		
			1x22			8	450		
		0.33	5x22			540	120	30	220
			4x22						260
			3x22						325
			2x22						475
1x22	135		30	8	525				



## Theory of Operation – Continued

### Positive Voltage Transitions

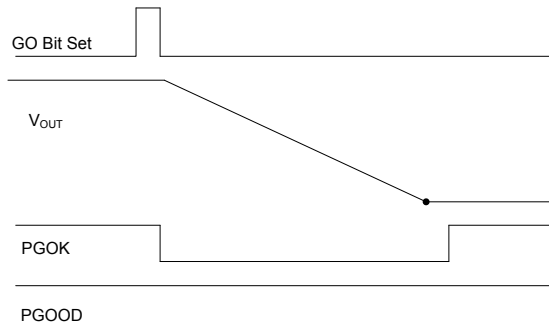
After the initial start-up sequence, the output voltage can be programmed to a new value by programming the VSEL register bits and then asserting the GO bit.  $V_{REF}$  will transition to the new value at the programmed slew rate. During the transition time the PGOK bit will be low and will go high when the transition completes.



**Figure 8 · Positive Voltage Transition**

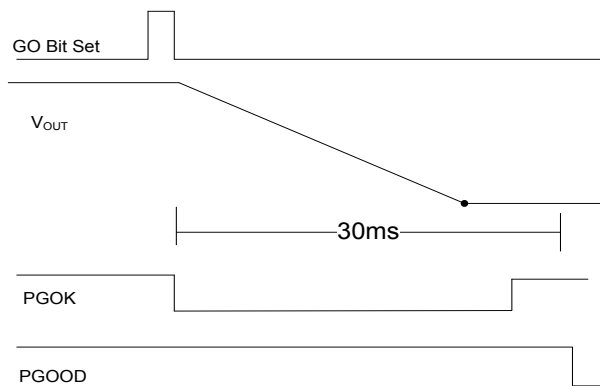
### Negative Voltage Transitions

A negative voltage transition occurs when a lower output voltage is programmed into the Vsel register, and initiated by asserting the GO bit. During the transition, when in PFM mode of operation, the upper PGOOD threshold is disabled if set.



**Figure 9 · Negative Voltage Transition**

If the FB voltage does not drop within 10% of the programmed voltage within 30 ms, then PGOOD will go low. During a transition when in PWM only mode of operation, the PGOOD thresholds will not be disabled but will trigger if the output falls outside the 10% tolerance window around the ramped programmed voltage.



**Figure 10 · Negative Voltage Transition PGOOD Fail**

## Enabling Regulator from I2C Bus

In addition to the EN pin, the regulator can be enabled and disabled via the I2C bus by programming the control register. During disable, the regulator and most of the support circuitry is turned off. However, the I2C bus circuitry is still active and may be programmed.

## I2C Interface

### I2C Port Functional Description

- Simple two wire, bidirectional, serial communication port.
- Multiple devices on same bus speeds from 400 kbps (FS-Mode) to 3.4 Mbps (HS-Mode).
- SOC Master controls bus.
- Devices listen for the unique address that precedes data.

### General I2C Port Description

The LX7180A includes an I2C compatible serial interface, using two dedicated pins: SCL and SDA for I<sup>2</sup>C clock and data respectively. Each line is externally pulled up to a logic voltage when they are not being controlled by a device on the bus. The serial port is an I<sup>2</sup>C slave that is clocked by the incoming SCL clock. The I<sup>2</sup>C port will support both the Fast mode (400 kHz max) and typically the High speed mode (3.4 MHz max). The data on the SDA line must be stable during the HIGH period of the clock signal (SCL). The state of the SDA line can only be changed when SCL is LOW (except for start, stop, and restart).

## Register Map

There are five 8-bit user-accessible registers. See the register map [Table 2](#).

## I2C Interface (Continued)

### Slave Address

In the Table 2, the A1 and A0 are the binary value of the address given in the Ordering Information.

7	6	5	4	3	2	1	0
1	1	0	1	0	A1	A0	R/W

Table 2 · I2C Slave Address

### START and STOP Commands

When the bus is idle, both SCL and SDA must be high except in the power up case where they may be held high or low during the system power up sequence.

The STX SOC (bus master) signals START and STOP bits signify the beginning and the end of the I2C transfer. The START condition is defined as the SDA signal transitioning from HIGH to LOW while the SCL line is HIGH. The STOP condition is defined as the SDA transitioning from LOW to HIGH while the SCL is HIGH. The STX SOC acts as the I2C master and always generates the START and STOP bits. The I2C bus is considered to be busy after START condition and free after STOP condition. During data transfer, STX SOC master can generate repeated START conditions. The START and the repeated START conditions are functionally equivalent.

### Data Transfers

Data is transferred in 8 bit bytes by SDA with the MSB transferred first. Each byte of data has to be followed by an acknowledge (ACK) bit. The acknowledged related clock pulse is generated by the master. The acknowledge occurs when the transmitter master releases the SDA line to a high state during the acknowledge clock. The SDA line must be pulled down by the receiver slave during the 9th clock pulse to signify acknowledgment. A receiver slave which has been addressed must generate an acknowledgement (“ACK”) after each byte has been received.

After the START condition, the STX SOC (I2C) master sends a chip address. The standard I2C address is seven bits long. Making the eighth bit a data direction bit (R/W). For the eighth bit (LSB), a “0” indicates a WRITE and a “1” indicates a READ. (For clarification, communications are broken up into 9-bit segments, one byte followed by one bit for acknowledging.) The second byte selects the register to which the data will be written. The third byte contains data to write to the selected register.

When a receiver slave doesn’t acknowledge the slave address, the data line must be left HIGH by the slave. The master can then generate a STOP command to abort the transfer. If a slave receiver does acknowledge the slave address but, sometime later in the transfer cannot receive any more data bytes, the master must again abort the transfer. This is indicated by the slave generating the not acknowledge on the first byte to follow.

The slave leaves the data line HIGH and the master generates the STOP command. The data line is also left high by the slave and master after a slave has transmitted a byte of data to the master in a read operation, but this is a not acknowledge that indicates that the data transfer is successful.

### Data Transfer Timing for Write Commands

In order to help assure that bad data is not written into the part, data from a write command is only stored after a valid STOP command has been performed.

## I2C Electrical Characteristics

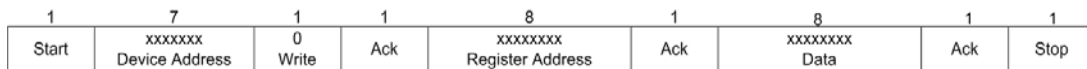
The minimum HIGH and LOW periods of the SCL clock are specified in the I2C Specifications, [Table 1](#) determine the maximum bit transfer rates of, 400 kbit/s for Fast-mode devices, and 3.4 Mbits/s for HS-mode Plus. Devices must be able to follow transfers at their own maximum bit rates, either by being able to transmit or receive at that speed or by applying the I2C clock synchronization procedure, which will force the master into a wait state and stretch the LOW period of the SCL signal. Of course, in the latter case the bit transfer rate is reduced.

[Figure 13](#) and [Figure 14](#) show all timing parameters for the HS & FS-mode timing. The ‘normal’ START condition S does not exist in HS-mode. Timing parameters for Address bits, R/W bit, Acknowledge bit and DATA bits are all the same. Only the rising edge of the first SCL clock signal after an acknowledge bit has a larger value because the external Rp has to pull-up SCL without the help of the internal current-source.

The HS & FS-mode timing parameters for the bus lines are specified in the I2C Specifications [Table 1](#). The minimum HIGH and LOW periods and the maximum rise and fall times of the SCL clock signal determine the highest bit rate.

With an internally generated SCL signal with LOW and HIGH level periods of 200 ns and 100 ns respectively, an HS-mode master fulfills the timing requirements for the external SCL clock pulses (taking the rise and fall times into account) for the maximum bit rate of 3.4 Mbit/s. So a basic frequency of 10 MHz, or a multiple of 10 MHz, can be used by an HS-mode master to generate the SCL signal. There are no limits for maximum HIGH and LOW periods of the SCL clock, and there is no limit for a lowest bit rate.

Timing parameters are independent for capacitive load up to 100 pF for each bus line allowing the maximum possible bit rate of 3.4 Mbit/s. At a higher capacitive load on the bus lines, the bit rate decreases gradually. The timing parameters for a capacitive bus load of 400 pF are specified in I2C Specifications [Table 1](#), allowing a maximum bit rate of 1.7 Mbit/s. For capacitive bus loads between 100 pF and 400 pF, the timing parameters must be interpolated linearly. Rise and fall times are in accordance with the maximum propagation time of the transmission lines SDA and SCL to prevent reflections of the open ends.



**Figure 11 · Write Protocol**



**Figure 12 · Read Protocol**

## I2C Interface (Continued)

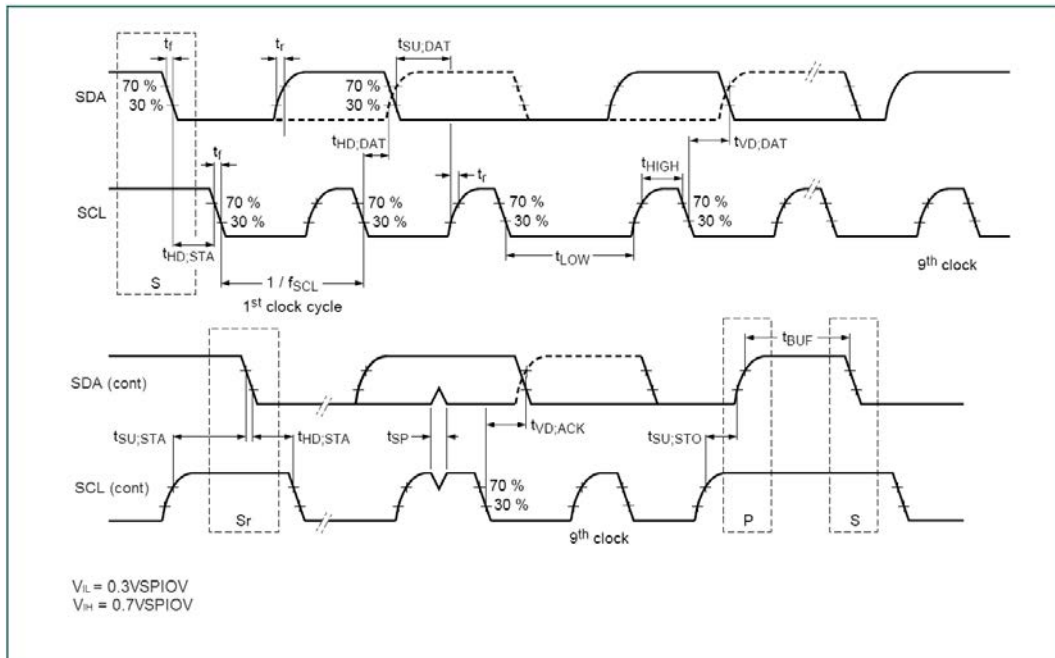


Figure 13 · Definition for FS-Mode devices on the I2C Port

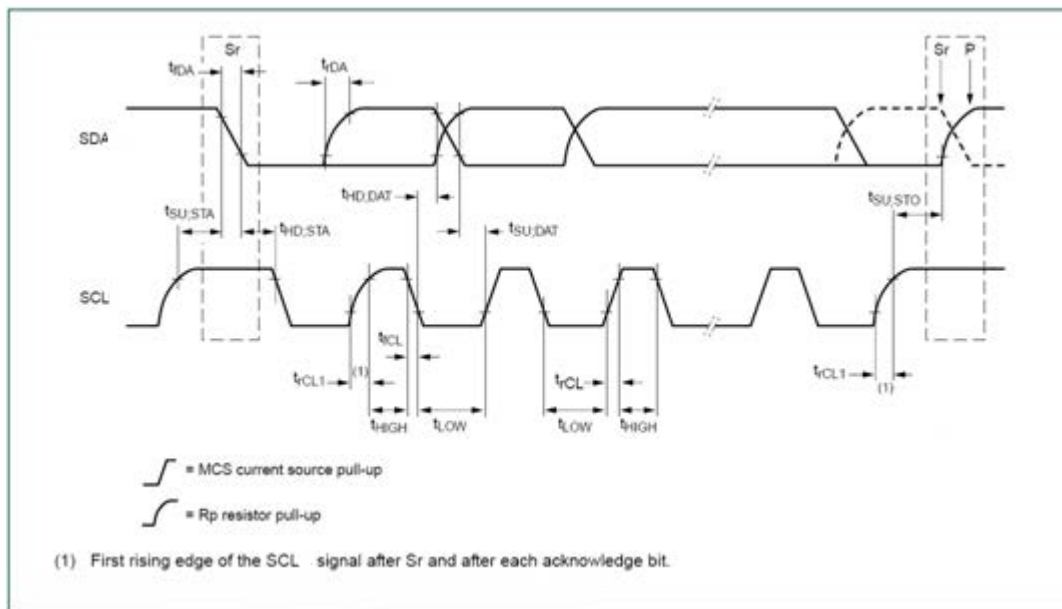
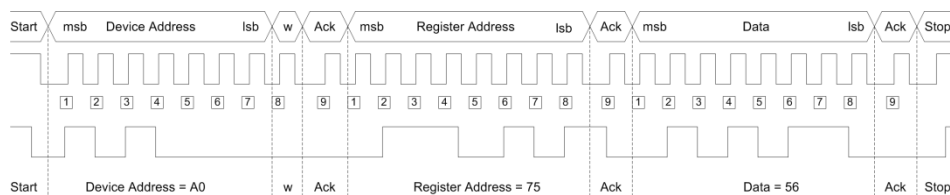
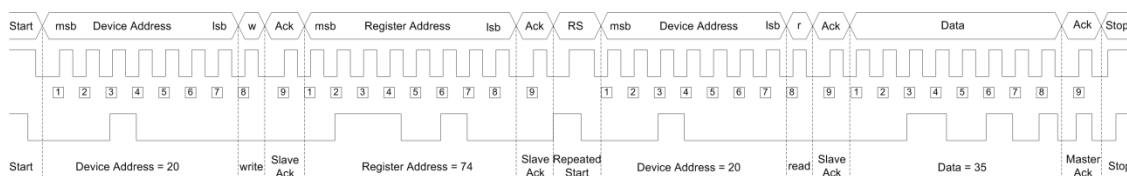


Figure 14 · Timing definition for HS-mode devices on the I2C Port

## I2C Interface (Continued)



**Figure 15 · Write Cycle Diagram**



**Figure 16 · Read Cycle Diagram**

## Control Register Bit Definition

Bit	Name	Value	Description
<b>Status, Address 00h</b>			
7:3	Reserved		
2	OCP	0-d	Latched to 1 if the over current limit is reached. Write a “1” to reset the status flag.
1	OTP	0-d	Latched to 1 if an over temperature event occurs. Write a “1” to reset the status flag.
0	FB_UVLO	0-d	Latched to 1 if a FB_UVLO event occurs. Write a “1” to reset the status flag.
<b>VSEL, Address 01h, (aka dac)</b>			
7	EN	1-d	Device enabled.
		0	Device disabled.
6:0	VSEL[6:0]		7-bit DAC value to set $V_{REF}$ . The default value is 0.9 V.
<b>Ctrl1, Address 02h, (aka reg2)</b>			
7:6	Reserved	00-d	
5	DLY_DIS	1-d	45 ms delay on PGOOD is disabled when this bit is high.
4	ctrl1	0-d	Not used
3	SW_RATE	1-d	Normal high efficiency rise rate.

Bit	Name	Value	Description
		0	Reduced switch node rise rate.
2	PG_LOHI	1-d	PGOOD will detect both a positive and negative excursion of $V_{OUT}$ from the reference.
		0	PGOOD senses only a negative voltage excursion of $V_{OUT}$ from the reference.
1	VIN_OVP	1-d	When $V_{IN}$ reaches $V_{IN}$ Max, the converter turns off.
		0	$V_{IN}$ OVP disabled. Converter will continue to operate
0	MODE	1-d	PWM – Always run in continuous conduction
		0	PSM – Power Save Mode allows the converter to run in discontinuous conduction
<b>Vendor ID, Address 03h (Read Only)</b>			
7:4	VID[3:0]	0010	Microsemi Vendor ID.
3:2	A1A0	00	Designates the slave address version. These bits will correspond to the two LSB bits.
1:0	VREF	01	Designates the default output voltage version, 00 = 0.6 V, 01 = 0.9 V, 10 = 1.0 V, 11 = 1.1 V.
<b>Ctrl2, Address 04h, (aka reg4)</b>			
7:6	Reserved		
5	GO	1	Write “1” to this bit to start a Vref transition
		0-d	The $V_{OUT}$ is ramped to the default VSEL Value.
4	Discharge	1	When the regulator is disabled, the output voltage is discharged through the SW pin.
		0-d	When the regulator is disabled, the output voltage is not discharged.
3	PGOK	1	Is high when output is in regulation, read only dynamic signal
		0	Is low during a output voltage transition, read only dynamic signal
2:0	SLEW	000	Reserved.
		001	Reserved.
		010	$V_{REF}$ slews at 2.5 mV/ $\mu$ s.
		011-d	$V_{REF}$ slews at 5 mV/ $\mu$ s; this is the default setting.
		100	$V_{REF}$ slews at 10 mV/ $\mu$ s.
		101	$V_{REF}$ slews at 20 mV/ $\mu$ s.
		110	$V_{REF}$ slews at 40 mV/ $\mu$ s.
111	Single Step Mode: No slew rate limiting.		

## Package Outline Dimensions

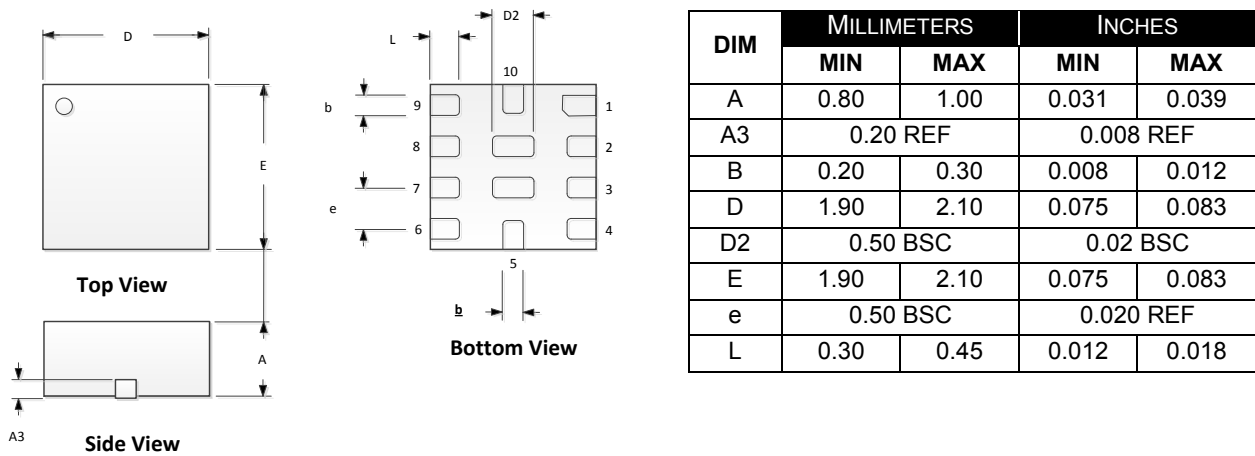
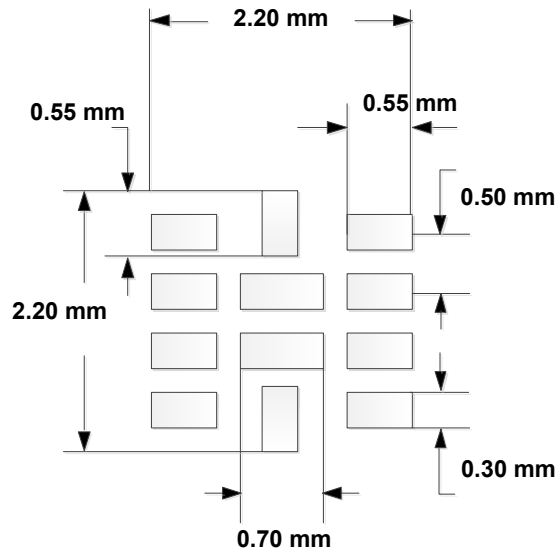


Figure 17 · QFN 2x2mm 12L Package Dimensions

- Note:**
1. Dimensions do not include mold flash or protrusions; these shall not exceed 0.155 mm (.006") on any side. Lead dimension shall not include solder coverage.
  2. Dimensions are in millimeters, inches for reference only.

## Land Pattern Recommendation



**Disclaimer:**

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